

# AK8778B

## Hall Effect IC for Pulse Encoders

### Overview

The AK8778B is a Hall effect latch which detects both "vertical magnetic field" and "horizontal magnetic field" (perpendicular and parallel to the marking side of the package) at the same time. The pulse output F and direction output D are switched according to the vertical and horizontal magnetic fields applied to the device. The direction is calculated internally and output D is switched at a rising or falling edge of output F. The AK8778B is for use in the incremental pulse encoders or rotational detection systems.

### Features

- 4.0 to 24V supply voltage operation
- o Sensitivity (Vertical, Horizontal) : ±1.7mT(Typ.)
- Two outputs : F (Pulse), D (Direction)
- o Small package: SOP-6pin
- o Halogen free

### Block Diagram

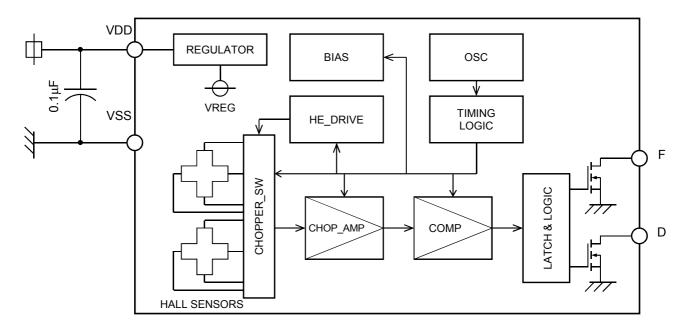


Figure 1. Block diagram

### Circuit Configuration

Table 1	. Circuit c	onfiguration
---------	-------------	--------------

Block	Function
REGULATOR	Generate internal operating voltage.
HALL SENSORS	Two Hall elements fabricated by CMOS process.
CHOPPER_SW	Perform chopping in order to cancel the offset of Hall sensor.
CHOP_AMP	Amplifies two Hall sensor output voltage with summation and subtraction circuit.
COMP	Hysteresis comparator.
BIAS	Generates bias current to internal circuits.
HE_DRIVE	Generates bias current for Hall sensors.
OSC	Generates operating clock.
TIMING LOGIC	Generates timing signal for internal circuits.
LATCH & LOGIC	Logical circuits and open drain driver.

### Pin/Function

Table 2. Description of pin name and t	function
--	----------

Pin No.	Pin name	I/O	Function	Note
1	VDD		Power supply pin	
2	TAB		(TAB pin)	
3	F	0	Output F (Pulse) pin	Open drain
4	D	0	Output D (Direction) pin	Open drain
5	TAB		(TAB pin)	
6	VSS		Ground pin	

Note) TAB pins should be connected to VSS.

### Absolute Maximum Ratings

Table 3. Absolute maximum ratings							
Parameter	Symbol	Min.	Max.	Unit	Note		
Supply voltage	V <sub>DD</sub>	-0.3	+32	V	VSS=0V		
Output voltage	V <sub>OUT</sub>	-0.3	+32	V	F,D pin VSS=0V		
Output current	I <sub>SINK</sub>		20	mA	F,D pin		
Storage temperature	T <sub>STG</sub>	-55	+150	°C			

Note) Stress beyond these listed values may cause permanent damage to the device.

### **Recommended Operating Conditions**

		1	υ		
Parameter	Symbol	Min.	Тур.	Max.	Unit
Supply voltage	V <sub>DD</sub>	4.0	12.0	24.0	V
Output current	I <sub>SINK</sub>			15	mA
Operating temperature	Ta	-40		+125	°C

#### Table 4. Recommended operating conditions

### **Electrical Characteristics**

			DD is i	,		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note
Current consumption	I <sub>DD</sub>	1.4	3.0	5.6	mA	
Output saturation voltage	V <sub>SAT</sub>			0.4	V	F, D pin, $I_{SINK}$ = 15mA
Output leak current	I <sub>LEAK</sub>			10	μA	F, D=V <sub>DD</sub>
Output refresh period	T <sub>P</sub>	12.0	16.7	30.5	μs	

Table 5. Electrical characteristics at  $V_{DD}$ =4.0 to 24.0V, Ta= -40 to +125°C

### **Magnetic Characteristics**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Note
Operating point of vertical magnetic field	BopV	0.1	1.7	4.0	mT	(*1)
Releasing point of vertical magnetic field	BrpV	-4.0	-1.7	-0.1	mT	(*1)
Operating point of horizontal magnetic field	BopH	0.1	1.7	4.0	mT	(*2)
Operating point of horizontal magnetic field	BrpH	-4.0	-1.7	-0.1	mT	(*2)
Hysteresis	BhV, BhH	1.5	3.4	6.8	mT	(*1), (*2)

Table 6. Magnetic characteristics at  $V_{DD}$ =4.0 to 24.0V, Ta= -40 to +125°C

(\*1) Horizontal magnetic flux density is zero.

(\*2) Vertical magnetic flux density is zero.

### **Operational Characteristics**

The internal signal A switches 'Low' state when the magnetic field perpendicular to the marking side of the package exceeds BopV. When the magnetic field is reduced below BrpV, the internal signal A goes 'High' state. Otherwise; that is, in case of the magnetic field strength is greater than BrpV and smaller than BopV; the internal signal A keeps its status.

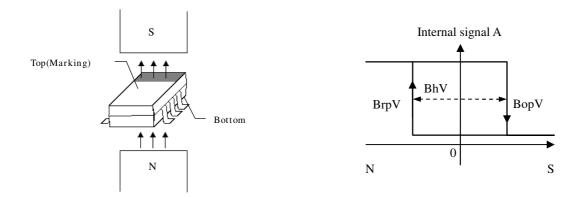


Figure 2. Switching behavior of the internal signal A when vertical magnetic field is applied

The internal signal B switches 'Low' state when the magnetic field parallel to the marking side of the package exceeds BopH. When the magnetic field is reduced below BrpH, the internal signal B goes 'High' state. Otherwise; that is, in case of the magnetic field strength is greater than BrpH and smaller than BopH; the internal signal B keeps its status.

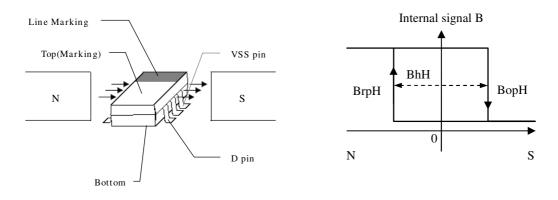
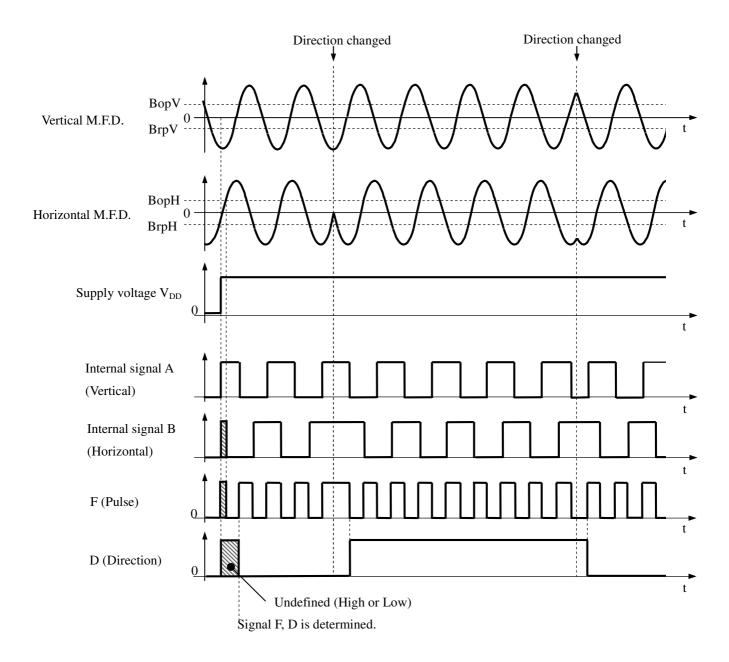
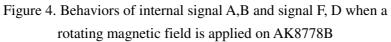


Figure 3. Switching behavior of the internal signal B when horizontal magnetic field is applied

#### Behaviors of internal signal A,B and output signal F, D when a rotating magnetic field is applied on AK8778B

F signal (pulse) is correspond to the result of EX-OR operation of internal signal A and B. And signal D (direction) is calculated by the state of internal signal A and B.





\*M.F.D. is Magnetic Flux Density.

Note) Signal D is determined after one signal F pulse is sent out. The indeterminate output state appears only in the powering up of this device.

### Functional Timing

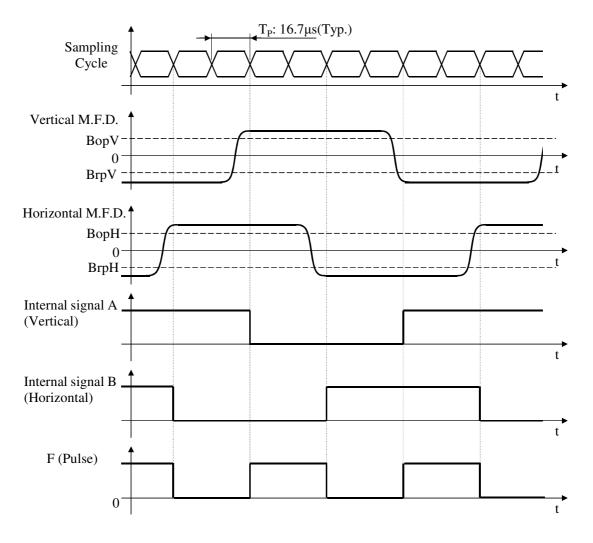


Figure 5. Timing diagram

\*M.F.D. is Magnetic Flux Density.

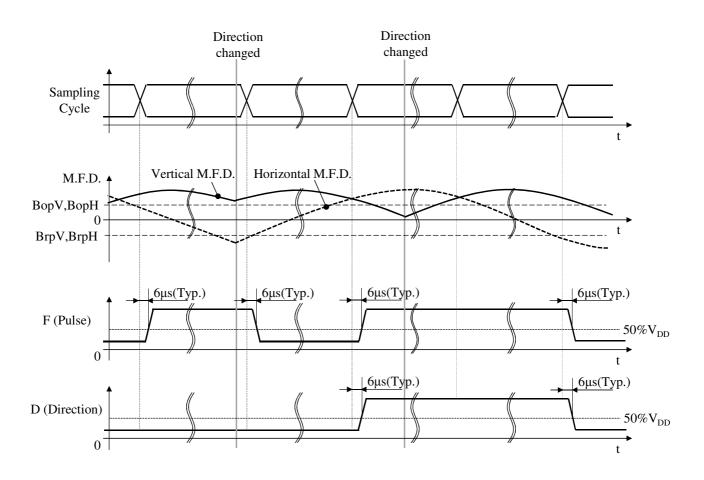
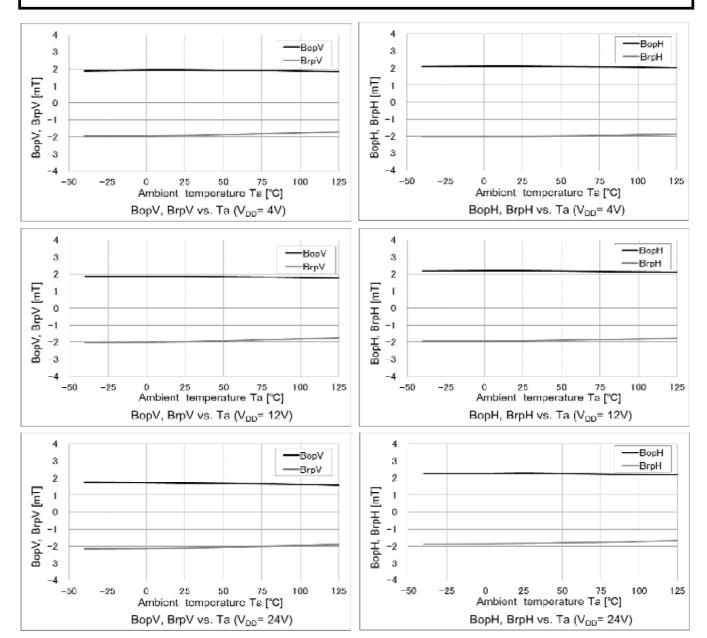


Figure 6. Timing diagram (in detail)

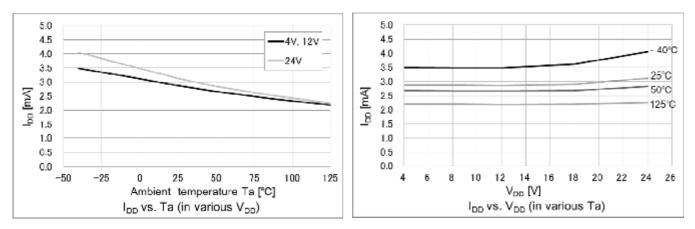
\*M.F.D. is Magnetic Flux Density.

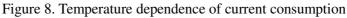
Note )  $V_{DD}$ =12.0V , $R_L$ =10k $\Omega$ ,  $C_L$ =20pF





#### Figure 7. Temperature dependence of sensitivity





### Package

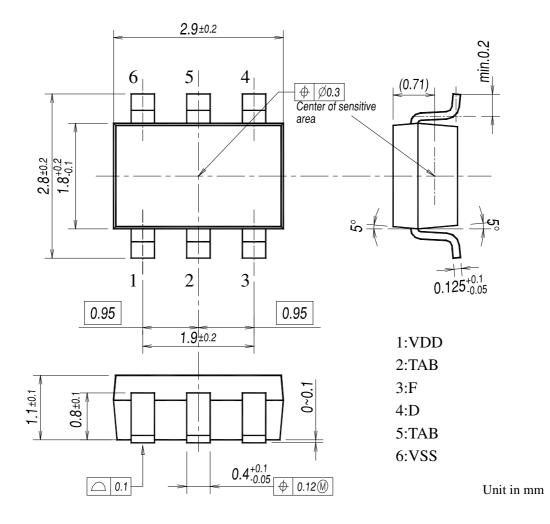


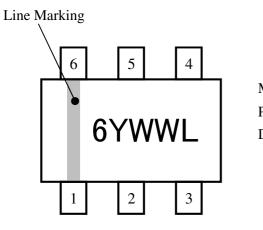
Figure 9. Package dimensions

Note 1) The center of the sensitive area is located within the  $\phi$ 0.3mm circle.

Note 2) Coplanarity: The differences between standoff of terminals are max. 0.1mm.

Note 3) The sensor part is located 0.71mm(Typ.) from marking surface.

Material of terminals: Cu alloy Material of plating for terminals: Sn 100% Thickness of plating for terminals: 10µm (Typ.) Marking



Marking is performed by laser Product name : 6 (AK8778B) Date code : YWWL Y : Manufactured year WW : Manufactured week L : Lot

Figure 10. Marking



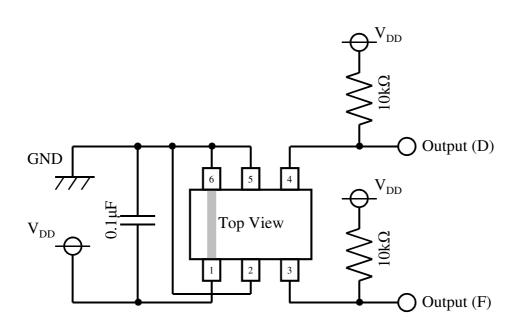


Figure 11. Recommended external circuit

#### **IMPORTANT NOTICE**

- These products and their specifications are subject to change without notice. I
- When you consider any use or application of these products, please make inquiries the sales office of Asahi Kasei Microdevices Corporation (AKM) or authorized distributors as to current status of the products.
- Descriptions of external circuits, application circuits, software and other related information contained in this document are provided only to illustrate the operation and application examples of the semiconductor products. You are fully responsible for the incorporation of these external circuits, application circuits, software and other related information in the design of your equipments. AKM assumes no responsibility for any losses incurred by you or third parties arising from the use of these information herein. AKM assumes no liability for infringement of any patent, intellectual property or other rights in the application or use of such information contained herein. I intellectual property, or other rights in the application or use of such information contained herein.
- Any export of these products, or devices or systems containing them, may require an export license or other official approval under the law and regulations of the country of export pertaining to customs and tariffs, currency exchange, or strategic materials.
- AKM products are neither intended nor authorized for use as critical components<sub>Note1</sub>) in any safety, life support, or
  - other hazard related device or system<sub>Note2</sub>), and AKM assumes no responsibility for such use, except for the use approved with the express written consent by Representative Director of AKM. As used here: Note1) A critical component is one whose failure to function or perform may reasonably be expected to result, whether directly or indirectly, in the loss of the safety or effectiveness of the device or system containing it, and which must therefore means used to response on a relatively. which must therefore meet very high standards of performance and reliability.
  - Note2) A hazard related device or system is one designed or intended for life support or maintenance of safety or for applications in medicine, aerospace, nuclear energy, or other fields, in which its failure to function or perform may reasonably be expected to result in loss of life or in significant injury or damage to person or property. It is the responsibility of the buyer or distributor of AKM products, who distributes, disposes of, or otherwise places
- the product with a third party, to notify such third party in advance of the above content and conditions, and the buyer or distributor agrees to assume any and all responsibility and liability for and hold AKM harmless from any and all claims arising from the use of said product in the absence of such notification.